

AQHVxx-01LTG Series 250W Discrete Unidirectional TVS Diode     



Description

The AQHVxx-01LTG series is designed to provide an option for very fast acting, high performance over-voltage protection components. This series is ideally suited for power interfaces, passenger charging interfaces, and well as LED lighting modules, and low speed I/Os. It will protect sensitive equipment from damage due to electrostatic discharge (ESD) and other overvoltage transients.

It can safely absorb repetitive ESD strikes above the maximum level of the IEC 61000-4-2 international standard (Level 4, ±8kV contact discharge) without performance degradation and safely conduct up to 10A (AQHV12) of induced surge current (IEC 61000-4-5 2nd edition, $t_p=8/20\mu s$) with very low clamping voltages.

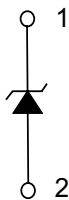
Pinout



Features

- ESD, IEC 61000-4-2, ±30kV contact, ±30kV air
- EFT, IEC 61000-4-4, 40A (5/50ns)
- Lightning, 10A (8/20 as defined in IEC 61000-4-5 2nd edition) for AQHV12
- Low clamping voltage
- PPAP capable
- Low leakage current
- AEC-Q101 qualified
- Moisture Sensitivity Level (MSL -1)
- Halogen free, lead free and RoHS compliant

Functional Block Diagram



Applications

- LED Lighting Modules
- Portable Instrumentation
- General Purpose I/O
- RS232 / RS485
- CAN and LIN Bus
- Automotive application

Life Support Note:

Not Intended for Use in Life Support or Life Saving Applications

The products shown herein are not designed for use in life sustaining or life saving applications unless otherwise expressly indicated.

Absolute Maximum Ratings

Symbol	Parameter	Value	Units
P _{pk}	Peak Pulse Power (t _p =8/20μs)	250	W
T _{OP}	Operating Temperature	-40 to 150	°C
T _{STOR}	Storage Temperature	-55 to 150	°C

Notes:

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the component. This is a stress only rating and operation of the component at these or any other conditions above those indicated in the operational sections of this specification is not implied.

AQHV12 Electrical Characteristics (T_{OP}=25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V _{RWM}	I _R =1μA			12.0	V
Breakdown Voltage	V _{BR}	I _R =1mA	13.3	14.3		V
Reverse Leakage Current	I _{LEAK}	V _R =12V		5	50	nA
Clamp Voltage ¹	V _C	I _{PP} =1A, t _p =8/20μs, I/O to GND		16.5	20	V
		I _{PP} =10A, t _p =8/20μs, I/O to GND		23.5	26	V
Dynamic Resistance ²	R _{DYN}	TLP, t _p =100ns, I/O to GND		0.22		Ω
Peak Pulse Current	I _{PP}	t _p =8/20μs			10.0	A
ESD Withstand Voltage ¹	V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±30			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance ¹	C _{I/O-GND}	Reverse Bias=0V, f=1MHz		55.5	60	pF

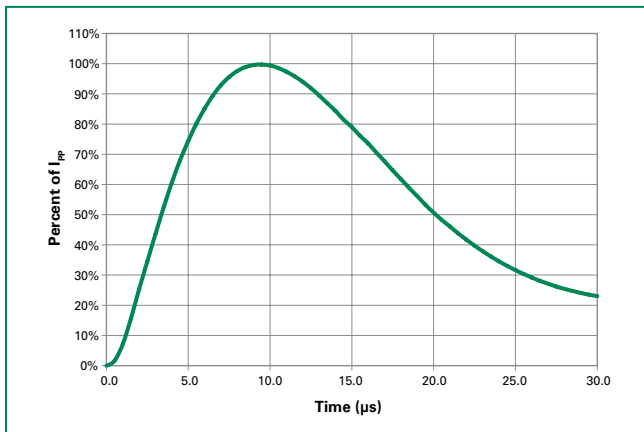
AQHV15 Electrical Characteristics (T_{OP}=25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V _{RWM}	I _R =1μA			15	V
Breakdown Voltage	V _{BR}	I _R =1mA	16.7	18.7		V
Reverse Leakage Current	I _{LEAK}	V _R =15V		5	50	nA
Clamp Voltage ¹	V _C	I _{PP} =1A, t _p =8/20μs, I/O to GND		21.5	25	V
		I _{PP} =7A, t _p =8/20μs, I/O to GND		30	35	V
Dynamic Resistance ²	R _{DYN}	TLP, t _p =100ns, I/O to GND		0.25		Ω
Peak Pulse Current	I _{PP}	t _p =8/20μs			7.0	A
ESD Withstand Voltage ¹	V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±30			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance ¹	C _{I/O-GND}	Reverse Bias=0V, f=1MHz		43	46	pF

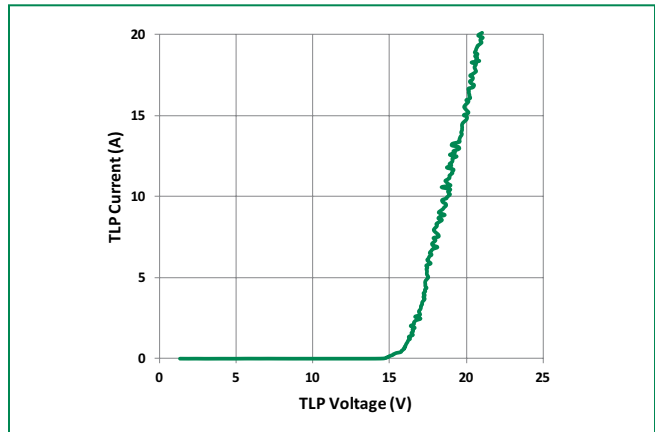
AQHV24 Electrical Characteristics (T_{OP}=25°C)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Units
Reverse Standoff Voltage	V _{RWM}	I _R =1μA			24	V
Breakdown Voltage	V _{BR}	I _R =1mA	26.7	28.7		V
Reverse Leakage Current	I _{LEAK}	V _R =24V		5	50	nA
Clamp Voltage ¹	V _C	I _{PP} =1A, t _p =8/20μs, I/O to GND		33	38	V
		I _{PP} =5A, t _p =8/20μs, I/O to GND		46.5	52	V
Dynamic Resistance ²	R _{DYN}	TLP, t _p =100ns, I/O to GND		0.35		Ω
Peak Pulse Current	I _{PP}	t _p =8/20μs			5	A
ESD Withstand Voltage ¹	V _{ESD}	IEC 61000-4-2 (Contact Discharge)	±25			kV
		IEC 61000-4-2 (Air Discharge)	±30			kV
Diode Capacitance ¹	C _{I/O-GND}	Reverse Bias=0V, f=1MHz		30	32	pF

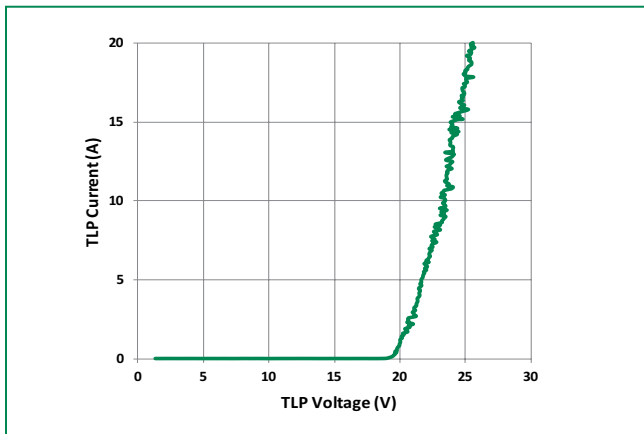
8/20μs Pulse Waveform



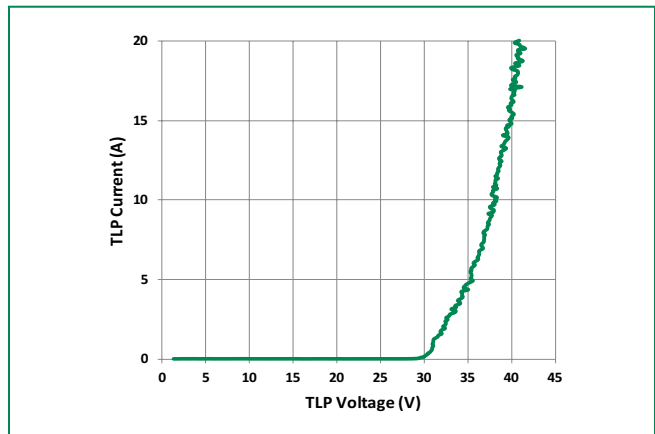
AQHV12 Transmission Line Pulsing(TLP) Plot



AQHV15 Transmission Line Pulsing(TLP) Plot

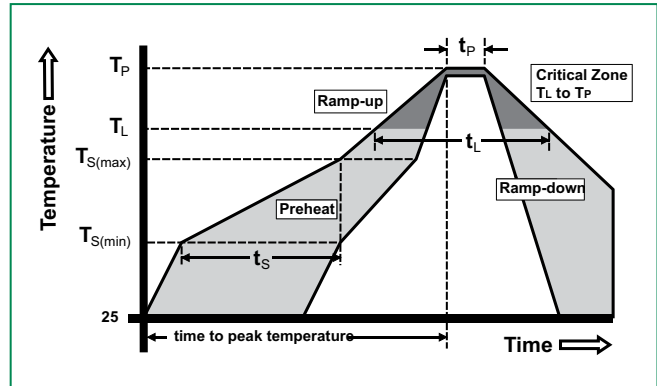


AQHV24 Transmission Line Pulsing(TLP) Plot



Soldering Parameters

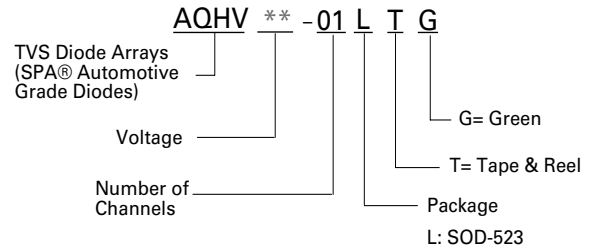
Reflow Condition	Pb – Free assembly	
Pre Heat	- Temperature Min ($T_{s(min)}$)	150°C
	- Temperature Max ($T_{s(max)}$)	200°C
	- Time (min to max) (t_s)	60 – 180 secs
Average ramp up rate (Liquidus) Temp (T_L) to peak	3°C/second max	
$T_{s(max)}$ to T_L - Ramp-up Rate	3°C/second max	
Reflow	- Temperature (T_L) (Liquidus)	217°C
	- Temperature (t_L)	60 – 150 seconds
Peak Temperature (T_p)	260 ^{+0/-5} °C	
Time within 5°C of actual peak Temperature (t_p)	20 – 40 seconds	
Ramp-down Rate	6°C/second max	
Time 25°C to peak Temperature (T_p)	8 minutes Max.	
Do not exceed	260°C	



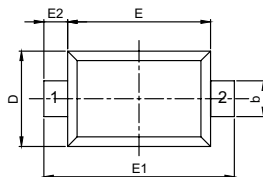
Product Characteristics

Lead Plating	Matte Tin
Lead Material	Copper Alloy
Substrate Material	Silicon
Body Material	Molded Compound
Flammability	UL Recognized compound meeting flammability rating V-0

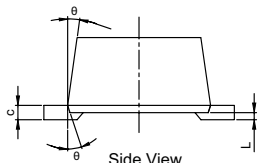
Part Numbering System



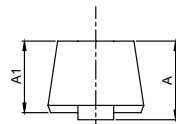
Package Dimensions – SOD-523



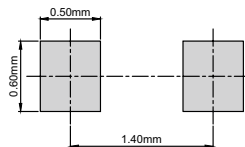
Top View



Side View



Side View

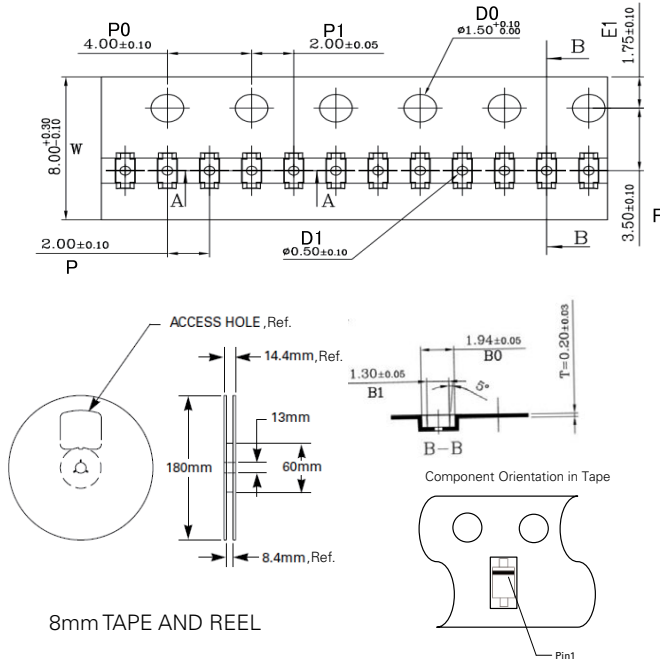


Recommended Soldering pad layout

Drawing#: L01-B

Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A	0.51	0.77	0.020	0.030
A1	0.50	0.70	0.020	0.028
b	0.25	0.35	0.010	0.014
c	0.08	0.15	0.003	0.006
D	0.70	0.90	0.028	0.035
E	1.10	1.30	0.043	0.051
E1	1.50	1.70	0.059	0.067
E2	0.20 REF		0.001 REF	
L	0.01	0.07	0.000	0.003
theta	7° REF		7° REF	

Embossed Carrier Tape & Reel Specification – SOD-523



Symbol	Millimeters		Inches	
	Min	Max	Min	Max
A0	0.91	1.01	0.036	0.040
B0	1.89	1.99	0.074	0.078
D0	1.50	1.60	0.059	0.063
D1	0.40	0.60	0.016	0.024
E1	1.65	1.85	0.065	0.073
F	3.40	3.60	0.134	0.142
P0	3.90	4.10	0.154	0.161
P	1.90	2.10	0.075	0.083
P1	1.95	2.05	0.077	0.081
K0	0.68	0.78	0.027	0.031
T	0.17	0.23	0.007	0.009
W	7.90	8.30	0.311	0.327

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